

## SIPMOS® Small-Signal Transistor

**BSS 91**

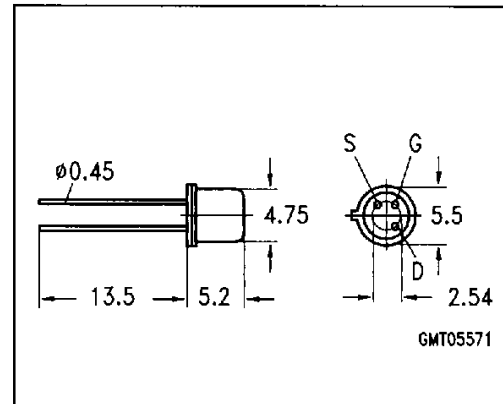
$$V_{DS} = 240 \text{ V}$$

$$I_D = 0.35 \text{ A}$$

$$R_{DS(on)} = 6.0 \ \Omega$$

- N channel
- Enhancement mode
- Package: TO-18 <sup>1)</sup>

**Not for new design!**



Type	Ordering code for version in bulk
■ BSS 91	Q 62702-S457

### Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	$V_{DS}$	240	V
Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$	$V_{DGR}$	240	
Gate-source voltage	$V_{GS}$	$\pm 14$	
Gate-source peak voltage, aperiodic	$V_{gs}$	$\pm 20$	
Continuous drain current, $T_C = 25 \text{ }^\circ\text{C}$	$I_D$	0.35	A
Pulsed drain current, $T_C = 25 \text{ }^\circ\text{C}$	$I_{D \text{ puls}}$	1.4	
Max. power dissipation, $T_A = 25 \text{ }^\circ\text{C}$	$P_{tot}$	1.5	W
Operating and storage temperature range	$T_J, T_{stg}$	$-55 \dots +150$	$^\circ\text{C}$
Thermal resistance, chip-ambient (without heat sink), chip-case	$R_{thJA}$	$\leq 300$	K/W
	$R_{thJC}$	$\leq 83$	
DIN humidity category, DIN 40 040	—	E	—
IEC climatic category, DIN IEC 68-1	—	55/150/56	—

<sup>1)</sup> See chapter Package Outlines.

**Electrical Characteristics**at  $T_j = 25\text{ °C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Static Characteristics**

Drain-source breakdown voltage $V_{GS} = 0, I_D = 0.25\text{ mA}$	$V_{(BR)DSS}$	240	–	–	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1\text{ mA}$	$V_{GS(th)}$	0.8	1.5	2.0	
Zero gate voltage drain current $V_{DS} = 240\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$	$I_{DSS}$	–	0.1	1.0	$\mu\text{A}$
$V_{DS} = 60\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$		–	–	200	nA
Gate-source leakage current $V_{GS} = 20\text{ V}, V_{DS} = 0$	$I_{GSS}$	–	10	100	nA
Drain-source on-resistance $V_{GS} = 10\text{ V}, I_D = 0.35\text{ A}$ $V_{GS} = 4.5\text{ V}, I_D = 0.35\text{ A}$	$R_{DS(on)}$	–	3.5	6.0	$\Omega$
		–	5.0	10.0	

**Dynamic Characteristics**

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}, I_D = 0.35\text{ A}$	$g_{fs}$	0.14	0.37	–	S
Input capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{iss}$	–	115	155	pF
Output capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{oss}$	–	15	25	
Reverse transfer capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{rss}$	–	8	12	
Turn-on time $t_{on}$ , ( $t_{on} = t_{d(on)} + t_r$ ) $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\text{ }\Omega, I_D = 0.28\text{ A}$	$t_{d(on)}$	–	6	9	ns
	$t_r$	–	10	15	
Turn-off time $t_{off}$ , ( $t_{off} = t_{d(off)} + t_f$ ) $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\text{ }\Omega, I_D = 0.28\text{ A}$	$t_{d(off)}$	–	33	45	
	$t_f$	–	22	30	

### Electrical Characteristics (cont'd)

at  $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

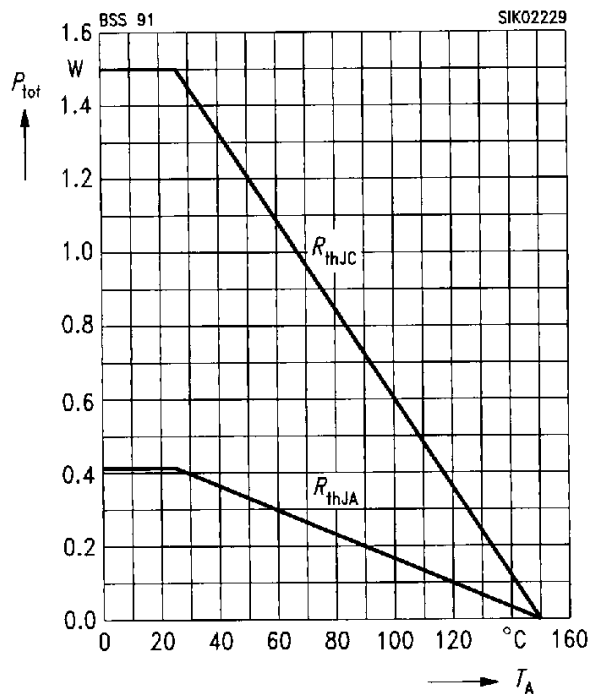
### Reverse Diode

Continuous reverse drain current $T_A = 25\text{ }^\circ\text{C}$	$I_S$	—	—	0.35	A
Pulsed reverse drain current $T_A = 25\text{ }^\circ\text{C}$	$I_{SM}$	—	—	1.4	
Diode forward on-voltage $I_F = 0.7\text{ A}$ , $V_{GS} = 0$	$V_{SD}$	—	0.9	1.4	V

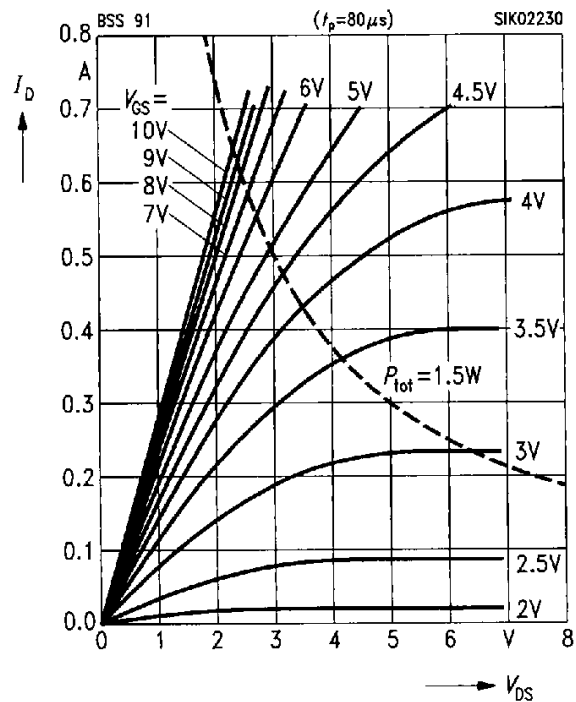
### Characteristics

at  $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified.

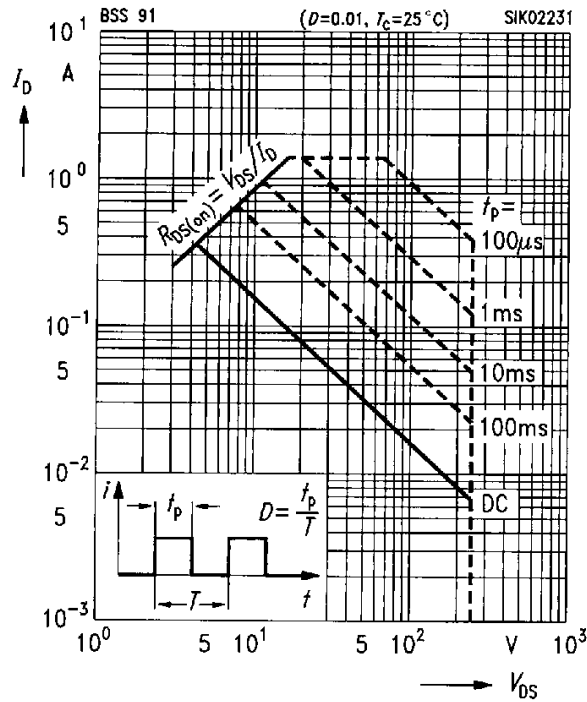
**Total power dissipation**  $P_{tot} = f(T_A)$



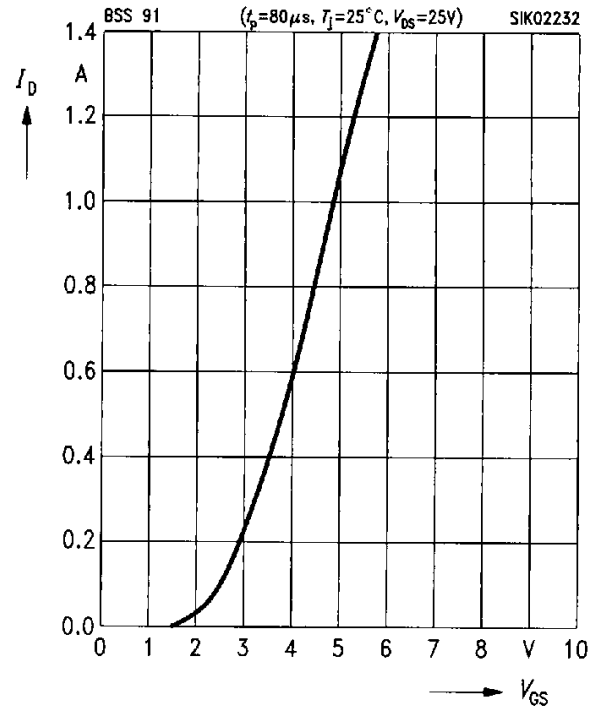
**Typ. output characteristics**  $I_D = f(V_{DS})$   
parameter:  $t_p = 80\text{ }\mu\text{s}$



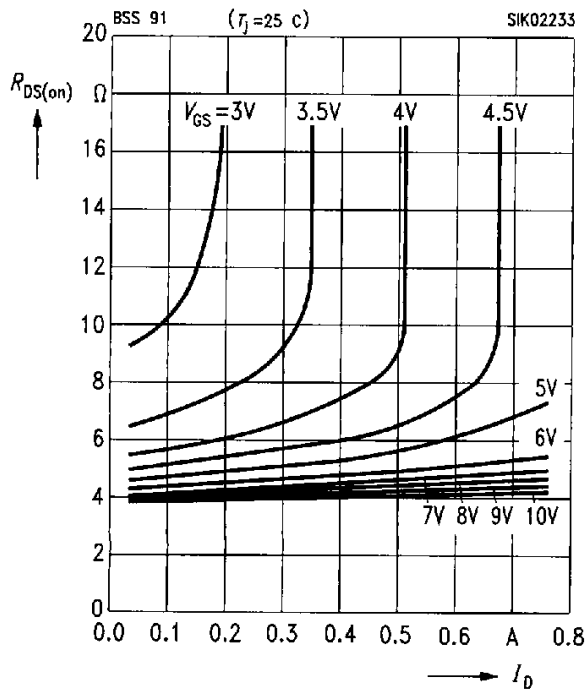
**Safe operating area  $I_D = f(V_{DS})$**   
parameter:  $D = 0.01, T_C = 25^\circ\text{C}$



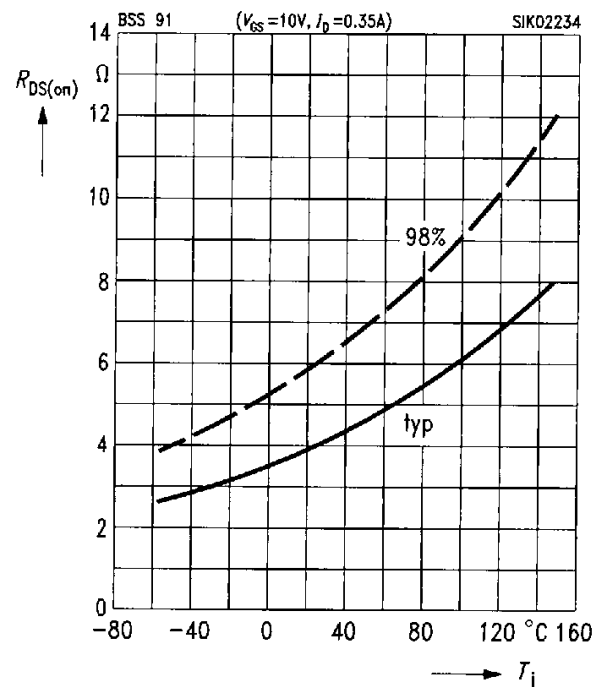
**Typ. transfer characteristics  $I_D = f(V_{GS})$**   
parameter:  $t_p = 80 \mu\text{s}, V_{DS} = 25 \text{ V}$



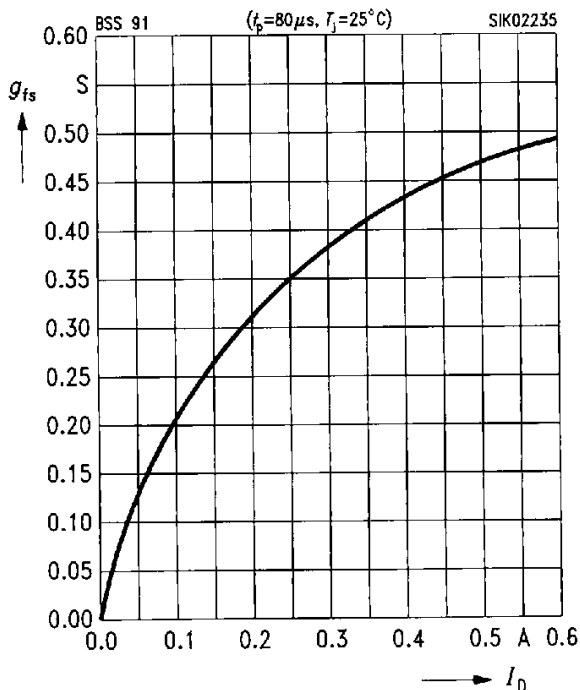
**Typ. drain-source on-resistance  $R_{DS(on)} = f(I_D)$**   
parameter:  $V_{GS}$



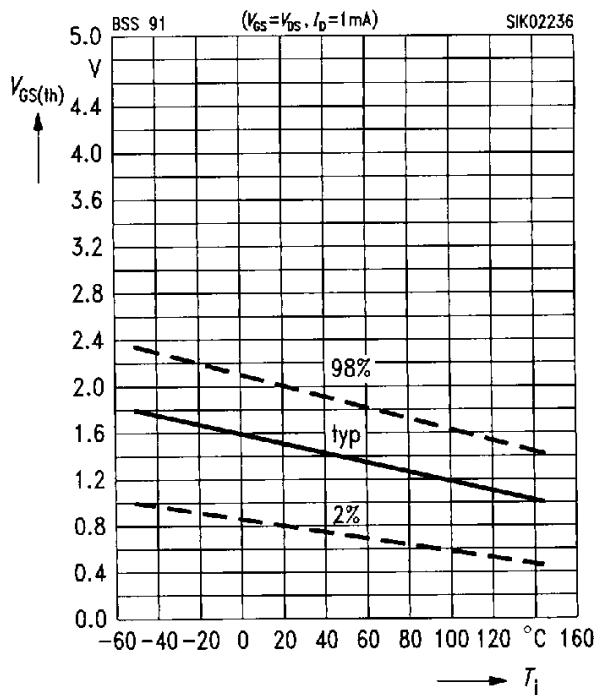
**Drain-source on-resistance  $R_{DS(on)} = f(T_J)$**   
parameter:  $I_D = 0.35 \text{ A}, V_{GS} = 10 \text{ V}, (\text{spread})$



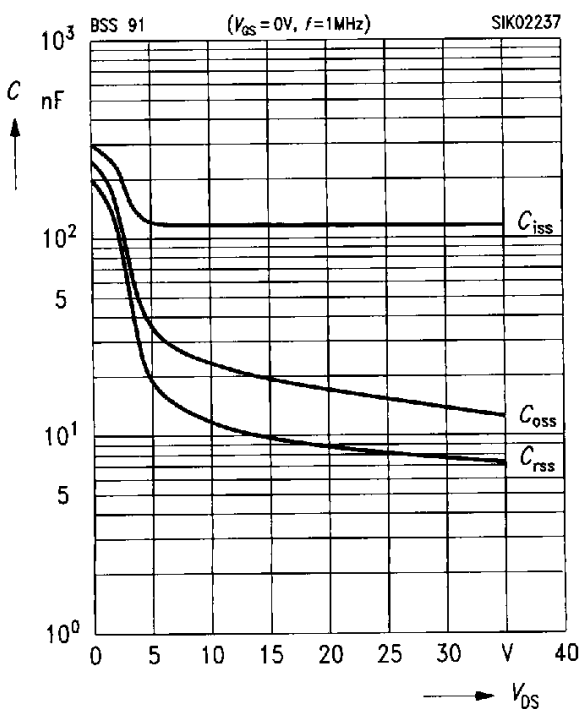
**Typ. forward transconductance**  $g_{fs} = f(I_D)$   
 parameter:  $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$ ,  $t_p = 80 \mu s$



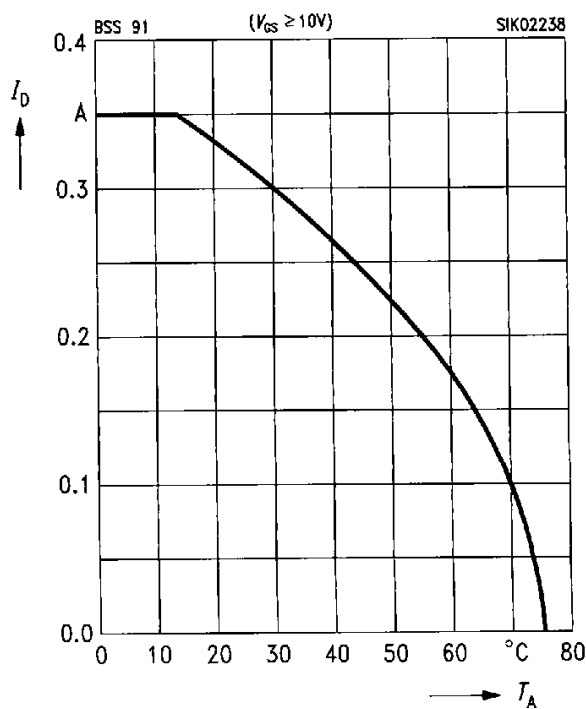
**Gate threshold voltage**  $V_{GS(th)} = f(T_j)$   
 parameter:  $V_{DS} = V_{GS}$ ,  $I_D = 1 \text{ mA}$ , (spread)



**Typ. capacitances**  $C = f(V_{DS})$   
 parameter:  $V_{GS} = 0$ ,  $f = 1 \text{ MHz}$



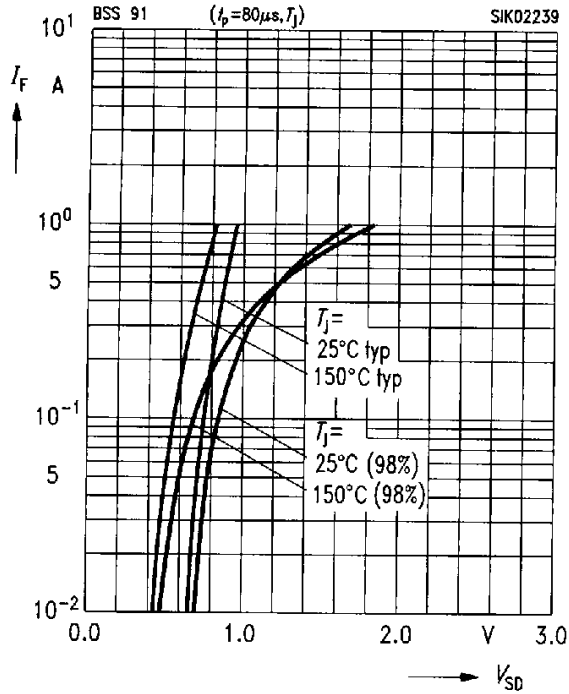
**Drain current**  $I_D = f(T_A)$   
 parameter:  $V_{GS} \geq 10 \text{ V}$



**Forward characteristics of reverse diode**

$I_F = f(V_{SD})$

parameter:  $t_p = 80 \mu s, T_j$ , (spread)



**Drain-source breakdown voltage**

$V_{(BR)DSS} = b \times V_{(BR)DSS} (25^\circ C)$

